Ph	0-1595 04 - 09 - 201	5ر	R SHEET U.S. DEPARTMENT OF COMMERCE
			Patent and Trademark Office
То	the Honorable Commissioner of 1024144	<u> 70</u>	attached original documents or copy thereof.
1	Name of conveying party(ies):	2	Name and address of receiving party(ies):
	Chin-Tsan Jan 7.27-03		Taiwan Semiconductor Manufacturing Co. Ltd. No. 121 Park Avenue 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.
3	Nature of conveyance: ■ Assignment □ Merger		Additional name(s) & address(es) attached □ Yes ☒ No
	☐ Security Agreement ☐ Change of Name		
	Other: Execution Date: November 3, 2002		
4	Application number(s) or patent number(s):		
	If this document is being filed together with a new application, the execution date of the application is:		
	A. Patent Application No(s).		B. Patent No(s)
	10402286		
	Additional numbers attached? □ Yes ⊠ No		
5	Name and address of party to whom correspondence concerning document should be mailed:	6	Total number of applications and patents involved: $\underline{1}$
	RANDY W. TUNG Tung & Associates	7	Total fee (37 CFR 3.41) \$40.00
	838 W. Long Lake Road Suite 120		□ Enclosed
	Bloomfield Hills, Michigan 48302		
		8	Deposit Account Number: 50-0484
/20/ • AA:	3 RHARIS1 00000026 10402286 40.00 DP		(Attach duplicate copy of this page if paying by deposit account)
1011	DO NOT US	E THI	S SPACE
9	Statement and signature.		
	To the best of my knowledge and belief, he foregoing in or the original document.	matior -	is true and correct and any attached copy is a true copy of
	Randy W. Tung Name of Person Signing Signature	_	March 27, 2003 Date
	Name of Person Signing Signature Registration No. 31,311		Date
	Total nur Mail documents to be recorded wit	nber of	pages including cover sheet, attachments, and document : 3

Washington, D.C. 20231

67,20≒**-986**

ASSIGNMENT

WHEREAS, I, CHIN-TSAN JAN, have invented certain improvements in

WAFER PROTECTION SYSTEM

for which I am about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of

No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of

acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and

valuable consideration, the receipt of which is hereby acknowledged, I, CHIN-TSAN JAN, by these

presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory

of the United States of America and all foreign countries, the entire right, title and interest, including

all priority rights under the International Convention associated with each country of the Union, in

and to said invention as described in the patent application executed by me on the 3rd day of

November, 2002, preparatory to obtaining Letters Patent of the United States thereon,

and in and to said application and any Letters Patent that may be granted in pursuance of said

application and any divisional, continuation or continuation-in-part application thereof, and in and

to any reissue of any such patent, and in and to any patent applications which may be filed on said

invention in countries foreign to the United States and any Letters Patent granted thereon.

1

PATENT REEL: 013921 FRAME: 0817

I further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and I further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

Chin- Jan Jan CHIN-TSAN JAN

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302

RECORDED: 03/27/2003

2

PATENT REEL: 013921 FRAME: 0818